	Serial No	).	2004-075	4
	DATE	: 2	2004/06/1	8
CRYSTAL				
(321G				
.0210				
00000MHz				
Please acknowledge rec attached hereto signing one copy thereof.				
ECIFICATION				
(sig	(nature)			
	(name)			
Pioneering New Brea	kthrough	ns in l	Electronic	 S
DAISHINKU (				
1389 Shinzaike, Hira 675-0194 Japan Pho Fax(0794)25-1134				ogo

C.ENG.

ENG.

QUARTZ CRYSTAL

**DSX321G** 

RECEIVED OF SPECIFICATION

32.00000MHz

MESSRS.:

ITEM:

DATE

**RECEIVED** 

NOMINAL FREQUENCY:

ITEM:

SPEC No.:

### 1. ELECTRICAL CHARACTERISTICS

(This test shall be performed under the conditions of temp.at 25 +/- 3deg. C, humidity 60% max.)

1. 1 NOMINAL FREQUENCY

32.000000 MHz

1.2 MODE

**Fundamental** 

1.3 LOADING CAPACITANCE

12.0 pF

1.4 FREQUENCY TOLERANCE

10 ppm Max. at +25 deg.C +/- 3 deg.C

1.5 DRIVE LEVEL

10 uW +/- 2 uW

1. 6 EQUIVALENT SERIES RESISTANCE

60 ohms Max. / Series

1.7 OPERATING TEMPERATURE RANGE

1.8 FREQUENCY TEMPERATURE CHARACTERISTICS

-40 deg.C

to +85 deg.C

+/-30

ppm Max. / -40

+85

to

deg.C

1. 9 SHUNT CAPACITANCE

2.0 pF Max.

1.10 INSULATION RESISTANCE

500 Mohms Min. / DC100V +/- 15V

1.11 STORAGE TEMPERATURE RANGE

-40 deg.C to +85 deg.C

### 2.CONSTRUCTION

2. 1 HOLDER

**DSX321G Ceramic Base** 

2. 2 DIMENSIONS AND MARKING

Refer to Fig.-1 and Table-1.

#### 3.OTHER SPECIFICATIONS

3. 1 EMBOSS CARRIER TAPE & REEL

Refer to Fig.-2,3,4,5 and Table-2.

3. 2 SPECIAL MATTERS

1.REFLOW CONDITIONS (REFERENCE)

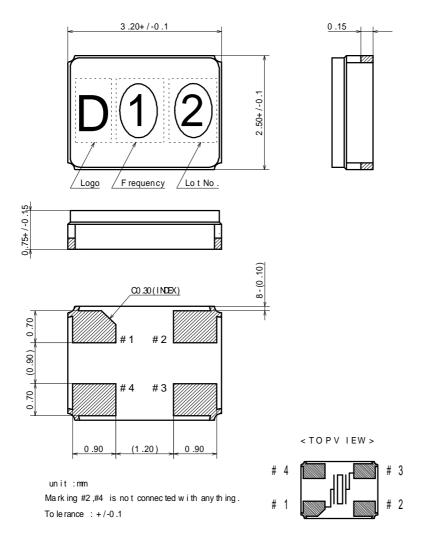
Refer to Fig.-6.

2.LAND PATTERN (REFERENCE)

Refer to Fig.-7.

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### < DIMENSIONS AND MARKING >



(Fig.-1)

Marking is Laser Marking:

Marking should be printed as follows:

Logo , Nominal Frequency , manufactured year & month

Nominal Frequency (1) = Mark two dights from upper

(ex. 32.000000 MHz --> 32 )

Manufacturing lot No.(2)

(year) ex. 2004 shall be marked as '4' (The last digit of the year)

(Month) ex. Jun. shall be marked as F'(As shown on the Table-1.)

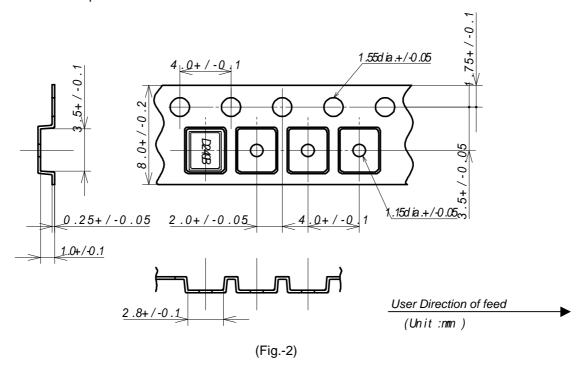
(Table-1)

Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
Α	В	С	D	E	F	G	Н	J	K	L	М

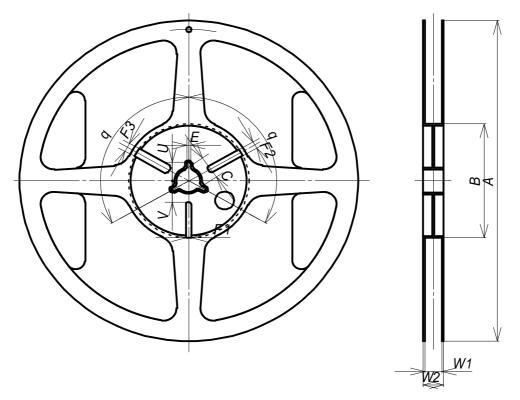
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### < EMBOSS CARRIER TAPE & REEL >

# (1)Dimensions of carrier tape



# (2)Dimensions of tape reel



(Fig.-3)

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# (Table-2)

(UNIT:mm)

	Item		Mark	Dimensions Angle
	Diameter	r	Α	180 dia. +0.0 / -3.0
Flange	Inside of Fra	inge	W1	9.0 + / - 0.3
i lariye	Outside of Fr	ange	W2	11.4 + / - 1.0
	Inside Diameter		В	60 dia. +1.0 / -0.0
			F1	3.0 + / - 0.2
	Center Core Slit	Width	F2	4.0 + / - 0.2
			F3	5.0 + / - 0.2
Center		Length	V	11.9
Core		Angle	q	120 deg.
	Spindle Diam	neter	С	13 dia. +/-0.2
		Width	E	2.0 +/-0.5
	Key Seats	Length	Ū	10.5 +/-0.4
		Angle	q	120 deg.

(3)Storage condition

Temperature: +40 deg.C Max. Relative Humidity: 80% Max.

(4)Standard packing quantity 3,000 pcs/reel for 180 dia.

# (5)Material of the tape

Tape	Material
Carrier tape	Polystyrene+Carbon
Top tape	Polyester

### (6)Label contents

Type

Our specification No.

Your Part No.

Lot No.

Nominal Frequency

Quantity

Our Company Name

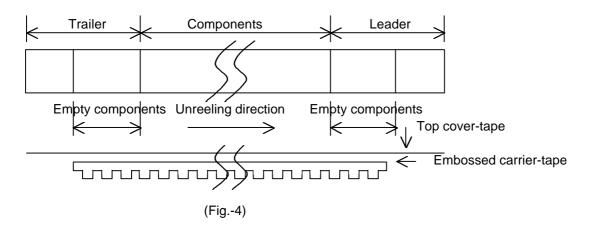
**Producting Country** 

Stick a label on the each reel.

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(7)Taping dimension

Leader	Cover-tape	The length of cover-tape in the leader is more than 400mm
	·	including empty embossed area.
	Carrier-tape	After all products were packaged, must remain more than
		twenty pieces or 400mm empty area, which should be sealed
		by cover-tape.
Trailer	Cover-tape	The tip of cover-tape shall be fixed temporary by paper
		tape and roll around the core of reel one round.
	Carrier-tape	The empty embossed area which are sealed by top cover-tape
		must remain more than 40mm.



### (8) Joint of tape

The carrier-tape and top cover-tape should not be jointed.

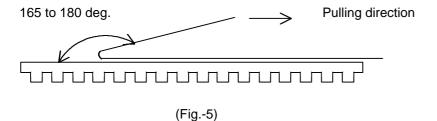
### (9) Release strength of cover tape

It has to between 0.1N to 0.7N under following condition.

Pulling direction 165 deg. to 180 deg.

Speed 300mm/min.

Otherwise unless specified.



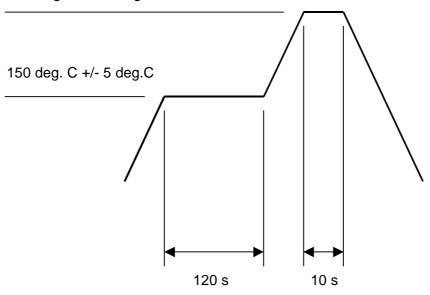
Other standards shall be based on JIS C 0806 <sub>-1990.</sub>

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### < REFLOW CONDITIONS (REFERENCE) >

During the solder reflow process, please complete within following temperature, period. Reflow soldering shall be allowed only two(2) times.

260 deg. C +/- 5 deg.C

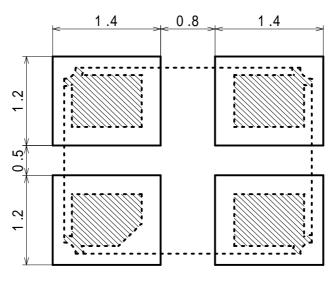


Total Time: 200s Max.

Solder melting point: 183 deg.C

(Fig.-6)

### < LAND PATTERN (REFERENCE) >



unit: mm

(Fig.-7)

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#### 1.MECHANICAL ENDURANCE

#### 1.1 SHOCK

After the following test, parts shall conform para.3-1-3. of this specifications 10cycles(60times) drop from 150 [cm] heights to concrete.

Further, parts shall be solderd on substrate, fixed bakelite materials (about 100[g]).

Substrate materials : Glass Epoxy

1 cycle : each 1 times of 6 directions

#### 1.2 VIBRATION

After the following test, parts shall conform para.3-1-2. of this specifications, and no abnormal appearance shall be observed.

(1)Frequency of Vibration : 10[Hz] to 55[Hz] (2)Amplitude(p-p) : Sine waves of 1.5[mm]

(3) Vibration axis : X.Y.Z

(4) Vibration period : 2 [h] for each axis

#### 1.3 SUBSTRATE BENDING

After the following test, parts shall conform para.3-1-2. of this specifications and no abnormality shall be observed in external appearance and sealing tightnen and others shall be based on ET-7403 of EIAJ.

Mount the specimen on substrate.

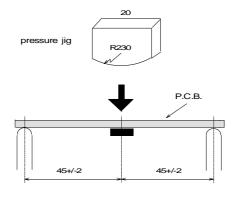
Apply the following pressure

 Direction
 : see Fig.-1

 Speed
 : 0.5 [mm/s]

 Hours
 : 5 +/- 1 [s]

 Amount of substrate
 : 3 [mm] Max.



(Fig.-1)

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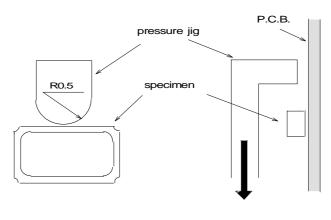
#### 1.4 SHEAR

After the following test, parts shall conform para.3-1-2. of this specifications and no abnormality shall be observed in external appearance and sealing tightness and others shall be based on ET-7403 of EIAJ.

Mount the specimen on substrate.

Apply the following pressure

Weight : 10 N Hours : 10 +/- 1 s Direction : see Fig.-2



(Fig.-2)

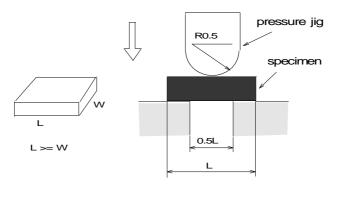
#### 1.5 BODY STRENGTH

After the following test, parts shall conform para.3-1-2. of this specifications and no abnormality shall be observed in external appearance and sealing tightness and others shall be based on ET-7403 of EIAJ.

Mount the specimen on substrate.

Apply the following pressure

Weight : 10 N Hours : 10 +/- 1 s Direction : see Fig.-3



(Fig.-3)

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#### 1.6 SEAL

Less than 2.0×10<sup>-9</sup> Pa m<sup>3</sup>/sec. by Helium leak detector. Also, no serial bubble is observed by Fluorinert tests.

#### 1.7 SOLDERABILITY

After the following test, more than 90% of lead shall be covered by new solder.

3 seconds +/- 1 second dip in 235 deg.C +/- 5 deg.C solder. (Use rosin type flux for solder.)

#### 2.ENVIRONMENTAL ENDURANCE

### 2.1 HUMIDITY

Two hours past at room temperature after following test, parts shall conform para.3-1-4. of this specifications. 240 hours +60 deg.C +/- 2 deg.C , relative humidity 85% +/- 5%.

#### 2.2 LOW TEMPERATURE

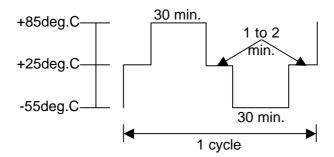
Two hours past at room temperature after following test, parts shall conform para.3-1-3. of this specifications. 240 hours -30 deg.C +/- 2 deg.C.

#### 2.3 HIGH TEMPERATURE

Two hours past at room temperature after following test, parts shall conform para.3-1-4. of this specifications. 240 hours +85 deg.C +/- 2 deg.C.

### 2.4 TEMPERATURE CYCLE

Two hours past at room temperature after 25 cycles of following test, parts shall conform para.3-1-3. of this specifications.



#### 2.5 RESISTANCE TO SOLDERING HEAT

24 hours past at room temperature from following test, parts shall conform para.3-1-2. of this specifications.

VPS:30 Seconds in FC-70 vapor(215 deg.C Boiling Point)

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### 3.SPECIFICATION

Frequency Variation and Equivalent Resistance shall be within Table-1 after the test.

(Table-1)

	Frequency Variation Equivalent Resistance		
3-1-1	±1[ppm]	±10[%] or 1[ohm] max. (Use larger specification)	
3-1-2	±2[ppm]	±15[%] or 2[ohm] max. (Use larger specification)	
3-1-3	±5[ppm]	±20[%] or 3[ohm] max. (Use larger specification)	
3-1-4	±10[ppm]	±20[%] or 3[ohm] max. (Use larger specification)	

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# 2004-0754 REVISION RECORD

Rev.No	Date	Reason	Contents	Approved	Checked	Drawn
-	2004/06/18		The first edition.	M.lizuka	H.Matsuda	M.Miyagawa